



B320B - B360B

3.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 125A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

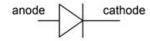
Mechanical Data

- Case: SMB
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 @3
- Polarity: Cathode Band
- Weight: 0.093 grams (approximate)









Top View

Bottom View

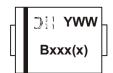
Ordering Information (Note 5)

Part Number*	Compliance	Case	Packaging
B3xxB-13-F	Standard	SMB	3000/Tape & Reel
B340BQ-13-F	Automotive	SMB	3000/Tape & Reel

^{*} xx = Device type, e.g. B320B-13-F (SMB package).

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
- 5. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information



Bxxx(x) = Product type marking code, ex: B320B] = Manufacturers' code marking YWW = Date code marking Y = Last digit of year (ex: 3 for 2013) WW = Week code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	B320B	B330B	B340B/ B340BQ	B350B	B360B	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$egin{array}{c} V_{RRM} \ V_{RWM} \ V_{R} \end{array}$	20	30	40	50	60	V
Average Rectified Output Current @ T _T =+100°C	Io			3.0			Α
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}			100			Α

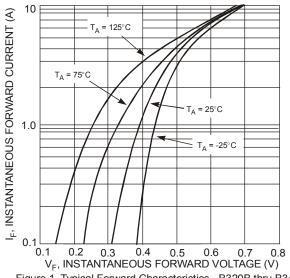
Thermal Characteristics

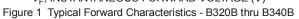
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal (Note 6)	$R_{ heta JT}$	25	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 6)	$R_{ heta JA}$	95	°C/W
Operating Temperature Range	TJ	-55 to +150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition	
Forward Voltage Drop	B320B,B330B,B340B,B340BQ B350B, B360B	\/-	_		0.50 0.70	٧	I _F = 3.0A, T _A = +25°C	
Leakage Current (Note 7)		I _R	_		0.5 20	m A	@ Rated V _R , T _A = +25°C @ Rated V _R , T _A = +100°C	
Total Capacitance		Ст	_		200	pF	V _R = 4V, f = 1MHz	

6. Thermal Resistance: Junction to terminal, unit mounted on glass epoxy substrate with 2x3mm copper pad. Notes: 7. Short duration pulse test used to minimize self-heating effect.





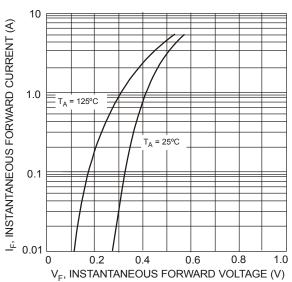


Figure 2 Typical Forward Characteristics - B350B thru B360B



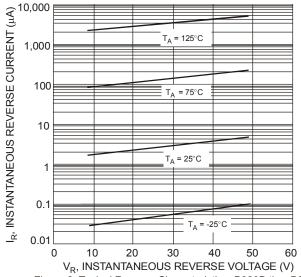
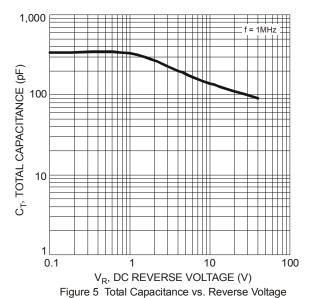
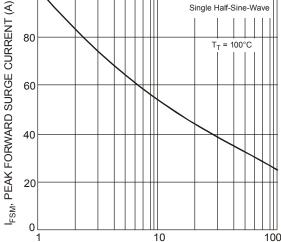


Figure 3 Typical Reverse Characteristics, B320B thru B340B



100



NUMBER OF CYCLES AT 60 Hz
Figure 7 Max Non-Repetitive Peak Forward Surge Current

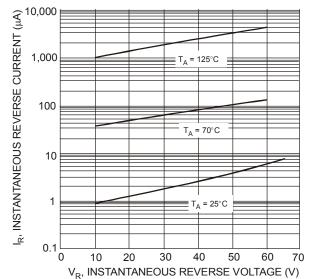


Figure 4 Typical Reverse Characteristics, B350B thru B360B

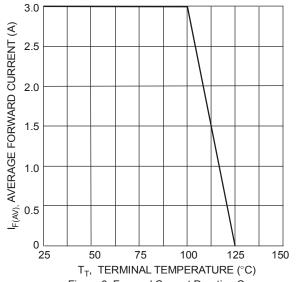
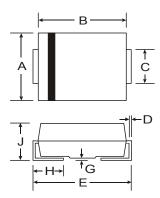


Figure 6 Forward Current Derating Curve

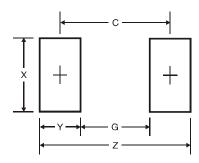


Package Outline Dimensions



SMB					
Dim	Min	Max			
Α	3.30	3.94			
В	4.06 4.57				
С	1.96 2.21				
D	0.15	5 0.31			
Е	5.00 5.59				
G	0.05 0.20				
Н	0.76 1.52				
J	2.00	2.50			
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)				
Z	6.8				
G	1.8				
Х	2.3				
Υ	2.5				
С	4.3				

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